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Form PTO-1595 (Rev. 10/02)	01-08-2		U.S. DEPARTMENT OF C U.S. Patent and Trade	
OMB No. 0651-0027 (exp. 6/30/2005) Tab settings ⇔ ⇔ ♥				_
To the Honorable Commissioner o	1026412	207	ed original documents or copy ther	eof.
1. Name of conveying party(ies): 1) CHOI, Myung Gyu 2) KIM, Hyung Sik	2.22.03	Name: <u>HYN</u>	ess of receiving party(ies) IX SEMICONDUCTOR IN	PT0 27 27 27 27 27 27 27 27 27 27 27 27 27
Additional name(s) of conveying party(les) atta	ched? 📮 Yes 🔼 No			U.S.
3. Nature of conveyance:				387 0/7
Security Agreement	Merger Change of Name		San 136-1, Ami-ri Ich'on, Kyoungki-do	
G Other	·	Republic of		
Execution Date: December 1, 20	003	Additional name(s)	& address(es) attached? 📮 Yes	M No
A. Patent Application No.(s)	Additional numbers att	ached? 📮 Yes 💆 No	•	
5. Name and address of party to whom concerning document should be ma		6. Total number of a	applications and patents inve	olved:
Name: Richard J. Streit		7. Total fee (37 CF	R 3.41)\$_40.00	
Internal Address:		Enclosed		
	Authorized to be charged to deposit account			
Street Address:c/o_Ladas & I	Parry	8. Deposit account	number:	
224 South Michigan Avenu		12	-0400	
City: Chicago State: IL	_z _{ip:_} 60604	(Attach duplicate cop	y of this page if paying by deposit	account)
	DO NOT USE	THIS SPACE		
9. Statement and signature. To the best of my knowledge and be is a true copy of the original document of Richard J. Streit Name of Person Signing Reg. 25765	ent.	Signature sheet, attachments, and	December 22,	
Mail docu		required cover sheet infor	mation to:	

DATE

PATENT REEL: 014850 FRAME: 0586

UNITED STATES OF AMERICA ASSIGNMENT

In consideration of the payment of ASSIGNEE to ASSIGNOR of the sum of One Dollar (\$1.00), the receipt of which is hereby acknowledged, and for the other good and valuable consideration,

ASSIGNOR:

Name: Myung Gyu CHOI

Address: 1 Hyangjeong-dong, Heungdeok-gu, Cheongju, Chungcheongbuk-do, Korea

Name: Hyung Sik KIM

Address: 104-910, Buyoung Apt., Yongam-dong, Sangdang-gu, Cheongju,

Chungcheongbuk-do, Korea

(INVENTOR NAME AND ADDRESS)

hereby sells, assigns and transfers to

ASSIGNEE:

Name: Hynix Semiconductor Inc.

Address: San 136-1, Ami-ri, Bubal-eub, Ich'on, Kyoungki-do, Korea

(ASSIGNEE NAME AND ADDRESS)

and the successors, assigns and legal representatives of the ASSIGNEE the entire right, title and interest for the United States and its territorial possessions in and to, any and all improvements which are disclosed in the invention entitled:

METHOD FOR FORMING ISOLATION LAYER OF SEMICONDUCTOR DEVICE

(TITLE)

and which is found in (check one applicable item below)

X	U.S. patent application	executed on even da	te herewith	
П	U.S. Application Serial	No.	filed on	

and, in and to all Letters Patent to be obtained for said invention by the above application or any continuation, division, renewal, substitute, reissue or re-examination thereof.

ASSIGNOR hereby convenants that no assignment, sale agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale;

PATENT REEL: 014850 FRAME: 0587 ASSIGNOR further convenants that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said invention and said Letters Patent and legal equivalents as may be known and accessible to ASSIGNOR and will testify as to the same in any interference or litigation related thereto and will promptly execute and deliver to ASSIGNEE or its legal representatives any and all papers, instruments or affidavits required to apply for, obtain, maintain, issue and enforce said application, said invention and said Letters Patent and said equivalents thereof which may be necessary or desirable to carry out the purposes thereof.

IN WITNESS WHEREOF, I/we have set our hand and seal

December	1, 2003	 	
_			

RECORDED: 12/22/2003

Date

Myung Gyu Choù INVENTOR: Myung Gyu CHOI

December 1, 2003

Date

Cim Hyungsik INVENTOR: Hyung Sik KIM

0699P/1

PATENT REEL: 014850 FRAME: 0588